

16 A Three-quadrant triacs high commutation Rev. 01 — 18 April 2007

Product data sheet

Product profile 1.

1.1 General description

Passivated, new generation, high commutation triacs in a SOT78 plastic package

1.2 Features

Sensitive gate Very high commutation performance maximized at each gate sensitivity

1.3 Applications

- High power motor control e.g. washing Refrigeration and air conditioning machines and vacuum cleaners
- Electronic thermostats

1.4 Quick reference data

- V_{DRM} \leq 600 V (BTA316-600D/E)
- V_{DRM} ≤ 800 V (BTA316-800E)
- I_{TSM} \leq 140 A (t = 20 ms)

High immunity to dV/dt

- compressors
- I_{GT} \leq 10 mA (BTA316 series E)
- $I_{GT} \le 5 \text{ mA} (BTA316-600D)$
- I_{T(RMS)} \leq 16 A

SOT78 (TO-220AB)

Pinning information 2.

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)	mb	N 1
2	main terminal 2 (T2)		T2-T1
3	gate (G)		`G sym051
mb	mounting base; main terminal 2 (T2)		



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3. Ordering information

Table 2. Ordering information							
Type number	Package						
	Name	Description	Version				
BTA316-600D	SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead	SOT78				
BTA316-600E		TO-220AB					
BTA316-800E							

4. Limiting values

Table 3.Limiting values

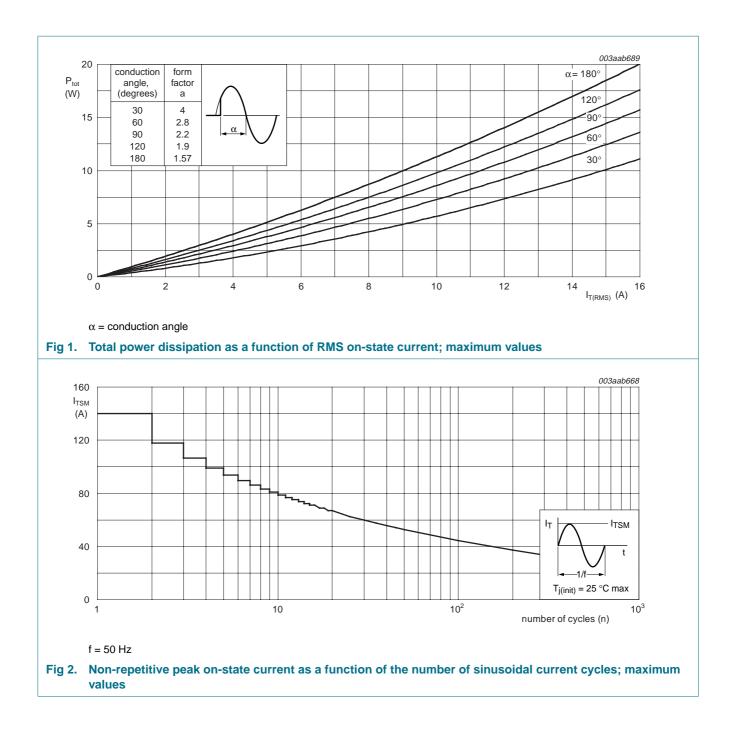
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage	BTA316-600D; BTA316-600E	<u>[1]</u> -	600	V
		BTA316-800E	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{mb} \le 101 \text{ °C}$; see Figure 4 and 5	-	16	A
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	140	А
		t = 16.7 ms	-	150	А
l ² t	I ² t for fusing	t = 10 ms	-	98	A ² s
dl _T /dt	rate of rise of on-state current	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
T _i	junction temperature		-	125	°C

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

BTA316 series D and E

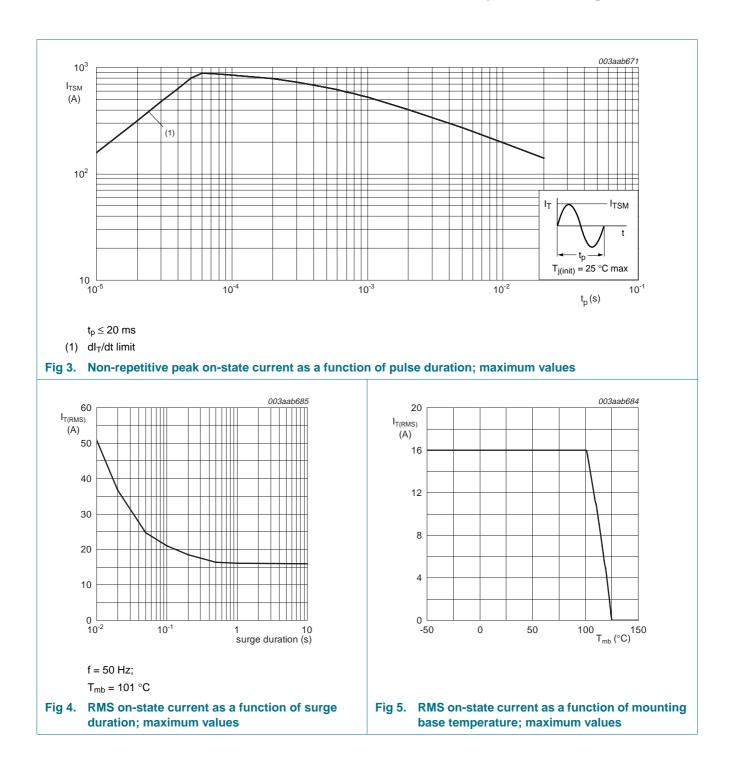
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BTA316 series D and E

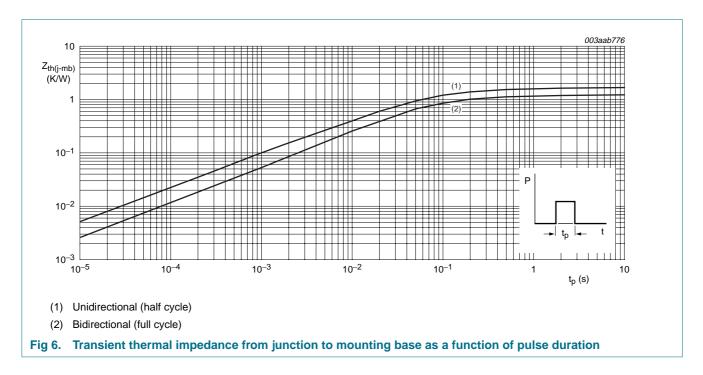
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Thermal characteristics 5.

Table 4.	mermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to	half cycle; see Figure 6	-	-	1.7	K/W
	mounting base	full cycle; see Figure 6	-	-	1.2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W



Thermal characteristics Table 4

BTA316_SER_D_E_1

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6. Static characteristics

Table 5. Static characteristics

 $T_i = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	B	TA316-6	600D		TA316-6 TA316-8		Unit
			Min	Тур	Max	Min	Тур	Max	
I _{GT}	gate trigger	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{100000000000000000000000000000000000$							
	current	T2+ G+	-	-	5	-	-	10	mA
		T2+ G-	-	-	5	-	-	10	mA
		T2- G-	-	-	5	-	-	10	mA
۱ _L	latching current	$V_{D} = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 10}{100000000000000000000000000000000$							
		T2+ G+	-	-	15	-	-	25	mA
		T2+ G-	-	-	25	-	-	30	mA
		T2- G-	-	-	25	-	-	30	mA
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 11}{100000000000000000000000000000000$	-	-	15	-	-	15	mA
V _T	on-state voltage	I _T = 18 A; see <u>Figure 9</u>	-	1.3	1.5	-	1.3	1.5	V
V _{GT}	gate trigger	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.7	1.5	-	0.8	1.5	V
	voltage	$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 125 \ ^\circ\text{C}$	0.25	0.4	-	0.25	0.4	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mA

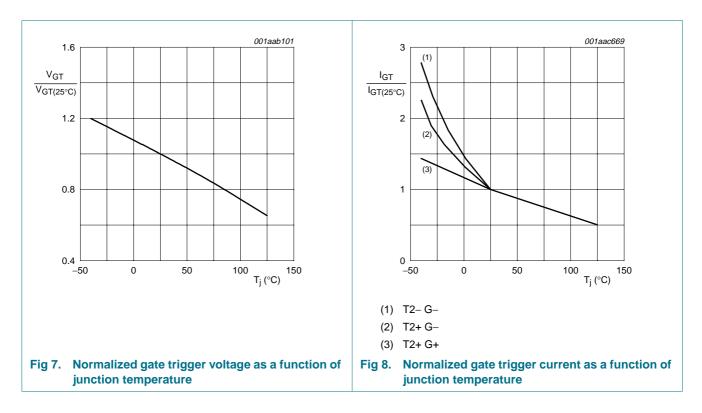
Table 0

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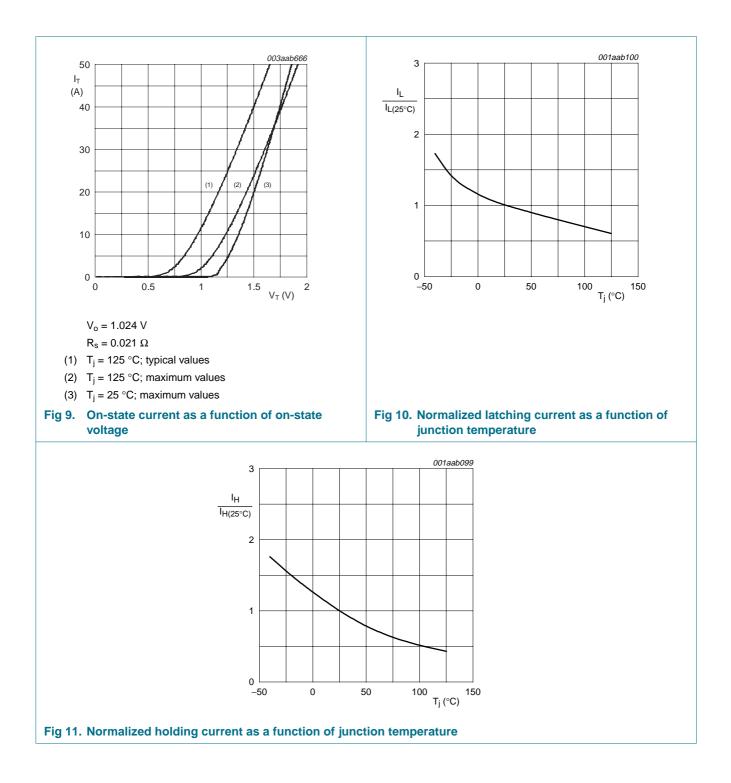
7. Dynamic characteristics

Dynamic cha	racteristics							
Parameter	Conditions		A316-6	00D		Unit		
		Min	Тур	Max	Min	Тур	Max	
rate of rise of off-state voltage	V_{DM} = 0.67 × $V_{DRM(max)}$; T _j = 125 °C; exponential waveform; gate open circuit	30	-	-	60	-	-	V/µs
rate of change of commutating current	V_{DM} = 400 V; T_j = 125 °C; $I_{T(RMS)}$ = 16 A; without snubber; gate open circuit	1.5	-	-	5	-	-	A/ms
	V_{DM} = 400 V; T _j = 125 °C; I _{T(RMS)} = 16 A; dV/dt = 10 V/µs; gate open circuit	3	-	-	8	-	-	A/ms
	V_{DM} = 400 V; T _j = 125 °C; I _{T(RMS)} = 16 A; dV/dt = 1 V/µs; gate open circuit	8	-	-	12	-	-	A/ms
gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A}; \\ dI_G/dt &= 5 A/\mu s \end{split}$	-	2	-	-	2	-	μs
	Parameter rate of rise of off-state voltage rate of change of commutating current gate-controlled	$ \begin{array}{ll} \mbox{rate of rise of off-state voltage} & V_{DM} = 0.67 \times V_{DRM(max)}; \ T_{j} = 125 \ ^{\circ}C; \\ \mbox{exponential waveform; gate open circuit} \\ \mbox{rate of change of commutating current} & V_{DM} = 400 \ V; \ T_{j} = 125 \ ^{\circ}C; \ I_{T(RMS)} = 16 \ A; \\ \mbox{without snubber; gate open circuit} \\ \ V_{DM} = 400 \ V; \ T_{j} = 125 \ ^{\circ}C; \ I_{T(RMS)} = 16 \ A; \\ \mbox{dV/dt} = 10 \ V/\mu s; \ gate open circuit} \\ \ V_{DM} = 400 \ V; \ T_{j} = 125 \ ^{\circ}C; \ I_{T(RMS)} = 16 \ A; \\ \mbox{dV/dt} = 10 \ V/\mu s; \ gate open circuit} \\ \ gate-controlled \ I_{TM} = 20 \ A; \ V_{D} = V_{DRM(max)}; \ I_{G} = 0.1 \ A; \end{array} $	ParameterConditionsBTParameterConditionsMinrate of rise of off-state voltage $V_{DM} = 0.67 \times V_{DRM(max)}; T_j = 125 \ ^C;$ exponential waveform; gate open circuit30rate of change of commutating current $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ without snubber; gate open circuit1.5 $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ dV/dt = 10 V/µs; gate open circuit3 $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ dV/dt = 10 V/µs; gate open circuit3gate-controlled $I_{TM} = 20 \ A; \ V_D = V_{DRM(max)}; \ I_G = 0.1 \ A;$ -	ParameterConditions $BTA316-6$ MinTyprate of rise of off-state voltage $V_{DM} = 0.67 \times V_{DRM(max)}; T_j = 125 \ ^C;$ exponential waveform; gate open circuit 30 -rate of change of commutating current $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ without snubber; gate open circuit 1.5 - $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ $dV/dt = 10 \ V/\mus;$ gate open circuit 3 - $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ $dV/dt = 10 \ V/\mus;$ gate open circuit 3 - $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ $dV/dt = 10 \ V/\mus;$ gate open circuit 8 - $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ $dV/dt = 10 \ V/\mus;$ gate open circuit 8 - $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ $dV/dt = 10 \ V/\mus;$ gate open circuit 8 - $V_{DM} = 400 \ V; T_j = 125 \ ^C; I_{T(RMS)} = 16 \ A;$ $dV/dt = 1 \ V/\mus;$ gate open circuit 2	ParameterConditions $BT \rightarrow 16-60 D$ MinTypMaxrate of rise of off-state voltage $V_{DM} = 0.67 \times V_{DRM(max)}; T_j = 125 \ ^C;$ exponential waveform; gate open circuit 30 $ -$ rate of change of commutating current $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; \ T_j = 125 \ ^C; \ I_{T(RMS)} = 16 \ A;$ $V_{DM} = 400 \ V; 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V_D = V_{DRM(max)}; I_G = 0.1 A;$ $ 2$ $ 2$	$ \begin{array}{c c c c c c c c c } \mbox{Parameter} & \mbox{Conditions} & \mbox{BTA316-60UE} & \mbox{BTA316-60UE} & \mbox{BTA316-60UE} & \mbox{BTA316-60UE} & \mbox{BTA316-80UE} & \mbox{Min} & \mbox{Typ} & \mbox{Max} & \mbox{Min} & \mbox{Typ} & \mbox{Min} & \mbox{Typ} & \mbox{Hyp} & \mbox{Typ} & \mbox{Hyp} & \mbox$



BTA316 series D and E

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8. Package outline

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				nal dime	nsions)		0	SC	lale							٦	
UNIT	Α	A ₁	b	b ₁	C	D	D ₁	E	е	L	L1	L ₂ max.	р	q	Q	_	
	4.7 4.1	1.40 1.25	0.9 0.6	1.45 1.00	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2		
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Fig 12. Package outline SOT78 (3-lead TO-220AB)

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9. Revision history

Table 7. Revision history	у			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA316_SER_D_E_1	20070418	Product data sheet	-	-

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10. Legal information

10.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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